infineon									
Material Content Data Sheet					RoHS		Halogen-Free		
Sales Product Name	SAF-XC836M-2FRI AB			Issued		27. February 2015			
MA#	MA001340690						•		
Package	PG-TSSOP-28-1			Weight*		107.13 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	4.495	4.20	4.20	41960	41960	
leadframe	non noble metal	nickel	7440-02-0	14.398	13.44		134392		
	non noble metal	iron	7439-89-6	19.882	18.56	32.00	185589	319981	
wire	noble metal	gold	7440-57-5	0.584	0.55	0.55	5451	5451	
encapsulation	organic material	carbon black	1333-86-4	0.190	0.18		1776		
	plastics	epoxy resin	-	8.055	7.52		75187		
	inorganic material	silicondioxide	60676-86-0	55.179	51.49	59.19	515059	592022	
leadfinish	non noble metal	tin	7440-31-5	1.539	1.44	1.44	14370	14370	
plating	noble metal	silver	7440-22-4	1.416	1.32	1.32	13214	13214	
glue	plastics	acrylic resin	-	0.279	0.26		2600		
	noble metal	silver	7440-22-4	1.114	1.04	1.30	10402	13002	
*deviation	< 10%			5	Sum in total:	100.00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.

2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be

proprietary, and thus CAS numbers and other limited information may not be available for release.

3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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